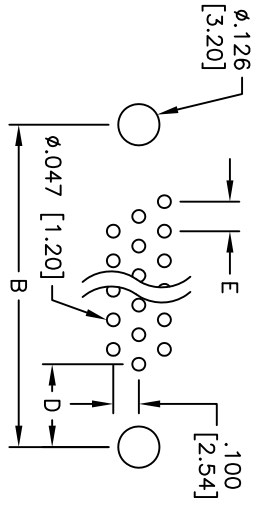
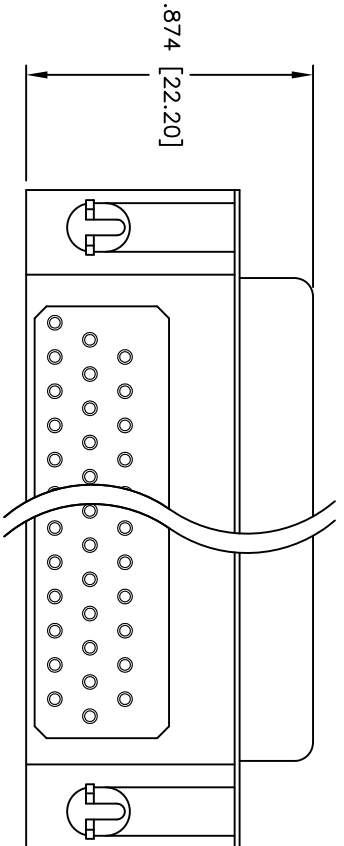
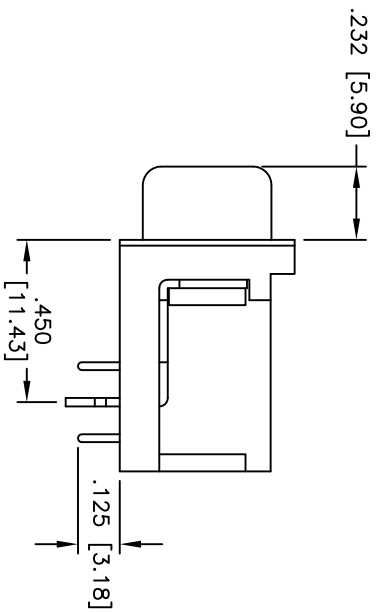
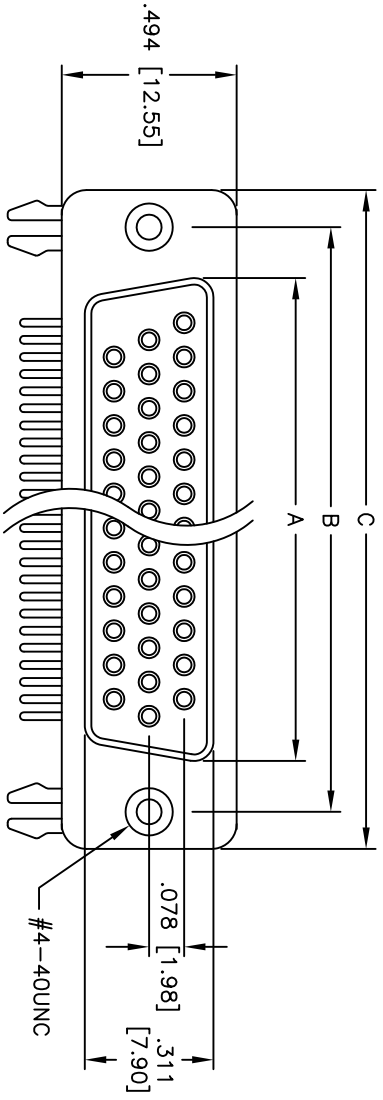


Rev	W/O #	Description	Date	Appr
-		RELEASED	1/10/11	

APPROVED: _____
 DATE: _____ TITLE: _____



HDTXX	DIMENSIONS				
	A	B	C	D	E
26	.971 [24.66]	1.312 [33.32]	1.541 [39.14]	.271 [6.88]	.090 [2.29]
44	1.511 [38.38]	1.852 [47.04]	2.088 [53.04]	.271 [6.88]	.090 [2.29]
62	2.159 [54.84]	2.500 [63.50]	2.729 [69.32]	.276 [7.00]	.095 [2.41]

SPECIFICATIONS:

Material: PBT, glass reinforced, rated UL 94V-0
 Insulator color: Black
 Contacts: Phosphor Bronze
 Shell: SPCC, Nickel plated
 Boardlock: Copper Alloy, Tin plated
 Rivet: Copper Alloy, Nickel plated
 Plating: Gold flash over Nickel underplate overall

Electrical:
 Operating voltage: 250 VAC max
 Current rating: 3 Amps max
 Contact resistance: 25 mohms max
 Insulation resistance: 5,000 Mohms min
 Dielectric withstanding voltage: 1,000 VAC for 1 minute
 Temperature Rating: Operating temperature: -55°C to +85°C
 Environmental:
 Lead free, RoHS compliant
 Recommended soldering temp: 235°C for 5 seconds



VALCONN ELECTRONICS INC.

909 Rahway Avenue, Union, NJ 07083
 Phone: 908-687-1600 Fax: 908-687-8599

TITLE: HIGH DENSITY D-SUB SOCKET, EMIFILT.
 #440 INSERTS

UNLESS OTHERWISE SPECIFIED ALL DIMENSIONS ARE INCHES [MM]		TOLERANCES: EXCEPT AS NOTED	
INCHES		HOLDS	
.X	± .10	ØXX	± .10
.XX	± .020	ØXXX	± .015
.XXX	± .015	ØXXXX	± .010
APPROVALS		DATE	
DRAWN	DY	1/10/11	
CHECKED			
APPROVED			
SIZE	PART NO.	SCALE	REV.
X	HDR-XXS-E	NTS	-
REF:		SHEET	1 OF 1